

U.S. PATENT DOCUMENTS[illegible][illegible]

Dr. Herbert J. Neuhaus et al.	"Manufacturing and Reliability of Chip Module to Antenna Coil Contacts in Dual Interface Smart Cards"	Int'l Microelectronics and Packaging Society Symposium; October 1999
Dr. Herbert J. Neuhaus	"Advances in Materials for Low Cost Flip-Chip"	Advancing Microelectronics, Vol. 27, No. 4 July/August 2000, pp.12-14
Dr. Michael E. Wernle	"Manufacturing of Low Cost Smart Labels"	Int'l Microelectronics Symposium; September 2000
EXAMINER <i>[Signature]</i>		DATE CONSIDERED <i>[Signature]</i>

EXAMINER: Initial if citation considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.